			DB	min at an a
L	Hits	Search Text) DR	Time stamp
Number				
13	7286	((29/830,831,846,852) or (427/96)).CCLS.	USPAT;	2002/09/04
			US-PGPUB;	13:39
			EPO; JPO;	
			DERWENT;	
	Í		IBM TDB;	
			USOCR	
14	1601	(((29/830,831,846,852) or	USPAT;	2002/09/04
1 1 1	1001	(427/96)).CCLS.) and (conductor or	US-PGPUB;	13:44
		conducting or copper) with (via or hole	EPO; JPO;	-3
		or passage) and layers	DERWENT;	
		or passage, and rayers	IBM TDB;	
			USOCR	
15	1116		USPAT;	2002/09/04
		(427/96)).CCLS.) and (conductor or	US-PGPUB;	13:45
		conducting or copper) with (via or hole	EPO; JPO;	
		or passage) and layers) and (dielectric	DERWENT;	
		or resin)	IBM_TDB;	
			USOCR	
16	465	(((((29/830,831,846,852) or	USPAT;	2002/09/04
		(427/96)).CCLS.) and (conductor or	US-PGPUB;	13:47
		conducting or copper) with (via or hole	EPO; JPO;]
		or passage) and layers) and (dielectric	DERWENT;	
		or resin)) and (stacking or stack or	IBM TDB;	
		bond or bonding or joining or join) with	USOCR	
	1	(layers)		
	I	\=-; =-;	1	